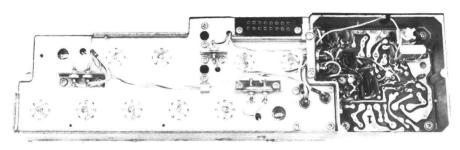


MASTR Progress Line

406-470 MC DUAL FRONT END MODELS 19D402799-G1 THRU G8 (WITH SEARCH-LOCK MONITOR)



SPECIFICATIONS

DUAL FRONT END

FREQUENCY RANGE

406-470 MC

SENSITIVITY

Standard DFE	With One Antenna	With Two Antennas
12-db SINAD	0.55 microvolt	0.5 microvolt
20-db Quieting	0.8 microvolt	0.7 microvolt
With UHS		
12-db SINAD	0.4 microvolt	0.35 microvolt
20-db Quieting	0.55 microvolt	0.45 microvolt
INTERMODULATION (EIA)	-60 db	
INPUT POWER	.010 Amps at 10 v	olts
FREQUENCY STABILITY	.0005% (-30° C to	+60°C)
TRANSISTORS	4 (5 in UHS model)
DIMENSIONS (HxWxD)	2-1/4" x 11-3/4"	x 4-3/8"

SEARCH-LOCK MONITOR

SEARCH RATE (Receiver squelched)	Samples each channel approximately 10 times per second.
INPUT POWER	.005 Amps at 10 volts
TRANSISTORS	3
TEMPERATURE RANGE	$-30^{\circ}\mathrm{C}$ to $+60^{\circ}\mathrm{C}$ (-22 $^{\circ}\mathrm{F}$ to $+140^{\circ}\mathrm{F}$)
DIMENSIONS (HxWxD)	2" x 2-3/4" x 3/4"

^{*}These specifications are intended primarily for the use of the serviceman. Refer to the appropriate Specification Sheet for the complete specifications.

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DESCRIPTION

DUAL FRONT END

General Electric Dual Front End Model 19D402799-Gl through -G8 was designed for operation in the 406-470 megacycle band. The Dual Front End (DFE) is used with MASTR Progress Line Receivers to monitor two frequencies when the channel spacing is greater than 0.4% ($\pm 0.2\%$). The DFE is available in two versions: a standard model and an ultrahigh sensitivity (UHS) model.

The DFE is of single-unit construction, completely housed in an aluminum casting for maximum shielding and rigidity. The unit consists of an RF amplifier, mixer, oscillator and two multiplier stages. The output feeds directly into the receiver 1st mixer stage as shown in Figure 1. The chassis is mounted in a housing on the rear of the mobile frame, adding approximately three inches to the overall length of the mobile unit.

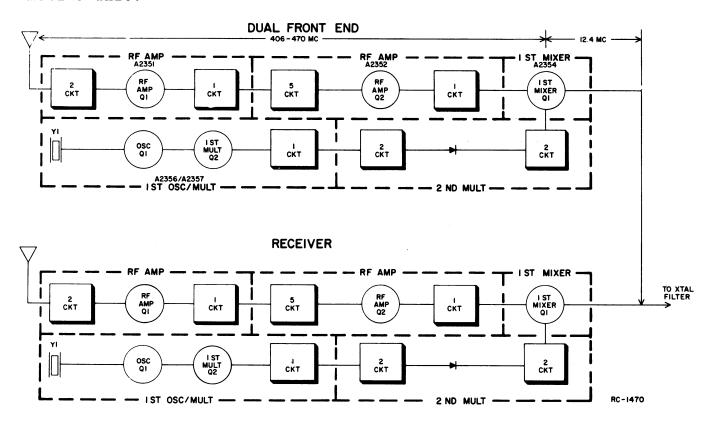


Figure 1 - Dual Front End Block Diagram

SEARCH-LOCK MONITOR

Mobile combinations with Dual Front End are also equipped with Search-Lock Monitor (SLM) to provide two-frequency monitoring. A three-position Search-Lock Monitor Switch (S705) is mounted on the mobile control unit. The switch has Fl, Fl-F2 and F2 positions. When the

switch is in the F1-F2 position, no voltage is fed from S705 to either receiver crystal-switching diode or the Dual Front End switching diode, and the Search-Lock Monitor operates. The Search-Lock Monitor then provides two-channel monitoring by alternately switching +10 volts between the receiver crystal-switching diode and Dual Front End switching diode at a rate of approximately 20 times per second. When a signal is received on either channel, the SLM "locks" on that frequency for the duration of the signal (see Figure 2).

Turning the switch to the Fl or F2 position applies +10 volts to the selected crystal-switching diode and overrides the SLM. Switching to the Fl or F2 position also connects the crystal-switching diode of the transmitter oscillator to ground, so that the receiver or Dual Front End will operate on the frequency determined by the selected transmitter and receiver/Dual Front End oscillator. With the switch in the Fl-F2 position, the transmitter will operate on the Fl frequency only.

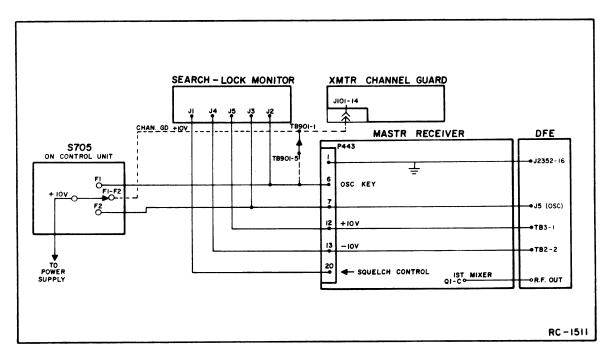


Figure 2 - Search-Lock Monitor Switching Diagram

In combinations equipped with Channel Guard, the receiver Channel Guard operates only in the Fl position. The transmitter Channel Guard operates in the Fl and Fl-F2 positions.

The Search-Lock Monitor board is mounted on the rear of the mobile system frame between the Dual Front End and the receiver.

ANTENNA SYSTEMS

The Dual Front End and the receiver may use a common antenna or separate antennas. If the two frequencies are in either the 406-420 or 450-470 megacycle range, one antenna will work satisfactorily. However, two antennas must be used to obtain maximum receiver sensitivity. The frequency range and antenna system used with each model DFE is shown in the following chart.

DUAL F STANDARD	RONT END WITH UHS	FREQUENCY RANGE	ANTENNA SYSTEM
19D402799-G1	19D402799-G3	406-420 MC	Two Antennas
19D402799-G2	19D402799-G4	450-470 MC	Two Antennas
19D402799-G5	19D402799-G7	406-420 MC	One Antenna
19D402799-G6	19D402799-G8	450-470 MC	One Antenna

Single Antenna System (Figure 3)

In the single antenna system, the antenna connects to jack J901 on the front of the mobile unit. From J901, the antenna connects to the common terminal of antenna relay K901. The transmitter connects to the normally open contact terminal of the antenna relay. The normally closed contact terminal of K904 is connected to the common terminal of the antenna "T" connector. One cable from the "T" connector goes to J1 on the Dual Front End and the other cable goes to J441 on the receiver.

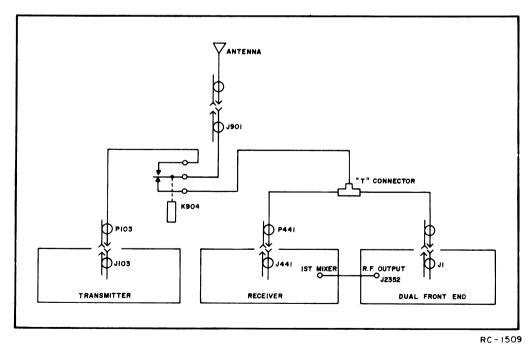


Figure 3 - Single Antenna Block Diagram

Dual Antenna System (Figure 4)

When two antennas are used, one antenna is connected through antenna jack J902 on the front of the mobile unit to jack J1 on the DFE. The second antenna is connected through J901 to the common terminal of antenna relay K904. The normally closed relay contact is connected to receiver antenna jack J441, and the normally open contact is connected to the transmitter.

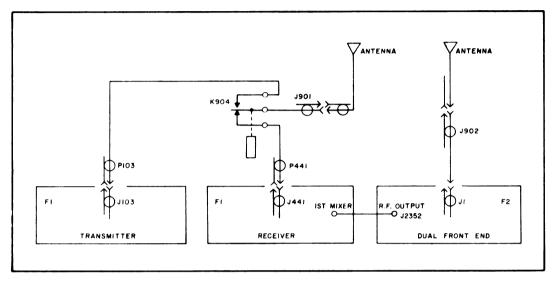


Figure 4 - Dual Antenna Block Diagram

RC - 1510

CIRCUIT ANALYSIS

DUAL FRONT END (19D402799-G1 through -G8)

The MASTR Progress Line Dual Front End is completely transistorized, using four silicon transistors (five in UHS models). A regulated 10 volts is used for all stages of the Dual Front End.

Centralized metering jack J2352 is provided for use with the General Electric Test Set Model 4EX3AlO for ease of alignment and servicing. The Test Set meters the oscillator, multipliers, and the regulated 10 volts.

RF Amplifier (A2351)

RF Amplifier A2351 is used only in the ultra-high sensitivity (UHS) Dual Front End, and consists of two tuned helical resonators and a transistorized amplifier stage.

The RF signal from the antenna is coupled through RF cable W2352 (for dual antennas) or W2354 (for single antennas) to a tap on L2351/L2354. The tap is positioned to provide the proper impedance match to the antenna. RF energy is coupled to the second coil through an opening in the shield wall, and then to the base of RF Amplifier Q1. Diode CRl protects Ql from damage by high signal levels. The output of Ql is developed across tuned circuit C3 and L1, and is coupled through five helical resonators to RF Amplifier A2352-Q2.

RF Amplifier (A2352)

RF Amplifier A2352 is used in both the standard and ultra-high sensitivity dual front end, and consists of five helical resonators and a transistorized RF amplifier stage. In standard models, the RF signal from the antenna is fed by RF cable W2351 (for dual antennas) or W2355 (for single antennas) to a tap on L2355/L2360. RF energy is then coupled through the five coils by openings in the shield walls to the base of RF Amplifier Q2. The output of Q2 is loop-coupled to the base of lst Mixer A2354-Q1.

1st Oscillator and Multiplier (A2356-A2357)

The receiver 1st oscillator operates in a transistorized Colpitts oscillator circuit. The oscillator crystal operates in a fundamental mode at a frequency of approximately 16 to 19 megacycles. The crystal is cut to provide temperature compensation at the high end of the temperature range and is thermistor compensated at low temperatures. This provides ±.0005% frequency stability as soon as the receiver is energized -- without having to wait for crystal ovens to warm up.

Regulated 10 volts is supplied to the crystal circuit to forward bias diode CR1. Forward biasing the diode reduces its impedance, so that the crystal frequency is applied to the base of oscillator transistor Q1. Feedback for the oscillator is developed across C47. The oscillator output is fed through C45 to the base of the 1st multiplier Q2.

The output of the 1st Multiplier (quadrupler Q2) is coupled through three tuned circuits (T7/T8, T2351/T2353 and T2352/T2354) to the 2nd Multiplier assembly. The 1st multiplier stage is metered at centralized metering jack J2352-4 through metering network CR6, R17 and R18.

2nd Multiplier Assembly

The 1st multiplier output is applied to the anode of multiplier diode CR2351. Following the multiplier diode are two helical resonator circuits that are tuned six times the 1st multiplier frequency for a total multiplication of 24 times the crystal frequency. The 2nd multiplier output is fed to the emitter of 1st Mixer A2354-Q1.

1st Mixer (A2354)

The RF signal from the RF amplifier is applied to the base of 1st mixer A2353-Q1 and the injection voltage from the 2nd multiplier is applied to the emitter of the 1st mixer. The 12.4 MC hi-IF mixer output is connected to the collector of the receiver 1st mixer stage through J2357.

The four leads from receiver plug P443 supplies the regulated 10 volts for the Dual Front End circuit, crystal switching, system negative, and ground connections.

SEARCH-LOCK MONITOR (19A121599-G1)

The SLM circuit consists of a pulse generator (Q1) and a bi-stable multivibrator circuit (Q2 and Q3). The pulse generator operates at a nominal frequency of 20 pulses per second.

When the receiver is squelched, 9 volts from the collector of the receiver DC amp (Q8) is fed through Jl and R2 on the SLM board to the base of pulse generator Q1. This voltage causes Q1 to operate, sending a series of pulses to the base of switching transistors Q2 and Q3. These pulses activate the switching circuit which alternately applies +10 volts to each receiver oscillator-switching diode at a rate of approximately 10 times per second.

When a signal is received, the receiver squelch opens; and the voltage at the base of Ql drops almost to zero. This disables the pulse generator and switching circuit, and the +10 volt input from J5 is applied through R11 and Q2 or Q3 to the receiver oscillator. For example, if the first call is received on F1, the +10 volt is applied to the F1 receiver oscillator through R11 and Q2, locking the receiver on F1. Subsequent signals at F2 will not be heard while the F1 signal is being received.

When the signal at Fl stops, the receiver squelches and 9 volts is fed to the base of pulse generator Ql. Then Q2 and Q3 begin to switch back and forth until another signal is received.

Back bias is prevented from reaching the collectors of Q2 and Q3 by CR1 and CR2. CR4 biases Q3 off while Q2 is conducting, thereby preventing Q3 from conducting while Q2 is operating. The pulse generator circuit consists of R1, R2, R3, R13, R14, R15, RT1, C1 and Q1.

MAINTENANCE

DISASSEMBLY

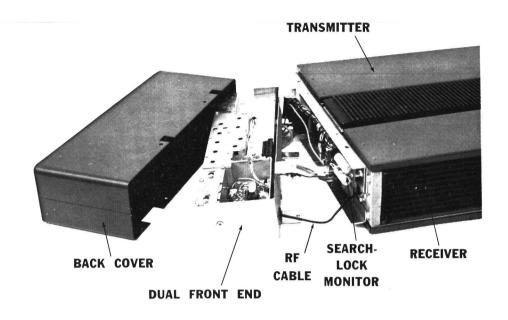


Figure 5 - Dual Front End Disassembly

Removing Dual Front End and/or Search-Lock Monitor:

Dual Front End

- 1. Pull locking handle down and pull radio out of mounting frame.
- 2. Remove the four screws holding back cover to system frame. Slide cover back and lift off (see Figure 5).
- 3. Remove four screws from angle brackets holding Dual Front End to the system frame.
- 4. Carefully swing Dual Front End chassis out for servicing.

Search-Lock Monitor

- 1. Same as Steps 1 through 4 above.
- 2. Remove three screws holding circuit board to system frame at rear of receiver).

TEST PROCEDURES

Dual Front End

SYMPTOM	CHECK THE FOLLOWING:
No Signal	1. Connections to P443.
	2. Cable from J2357 to receiver mixer board.
	3. Antenna terminal connections.
	4. Search-Lock Monitor switching circuit.
	5. Check 10-volt supply with G-E test meter at pin 13 on DFE centralized metering jack J2352.
Low Sensitivity	1. DFE alignment.
	2. Cable and relay connections.
	3. RF Amplifier voltages (A2351-Q1 or A2352-Q2).
	4. 1st Oscillator voltages (A2356/A2357-Q1).
Low Oscillator Reading	1. Oscillator alignment
Reading	2. Voltage readings at 1st Oscillator Q1.
	3. Crystal Y1.

Search-Lock Monitor

- 1. Turn the SLM switch to the F1-F2 (Search-Lock) position and make sure that the receiver is squelched.
- 2. Connect positive probe of oscilloscope to junction of Rl and CRl (for Fl) or R22 and CR2 (for F2) on the receiver oscillator board. Connect negative probe to J442-8 (negative). If SLM is operating, the signal should vary from zero to a positive voltage approximately 10 times per second.
- 3. Next, unsquelch the receiver. The Search-Lock circuit will lock on one of the channels. The oscilloscope reading should be less than one volt on OFF channel (not conducting) and 6.6 volts on ON channel (conducting).
- 4. Switch to the Fl position. Reading at junction of Rl and CRl should be approximately 6.6 volts. Then switch to the F2 position. Reading at junction of R2 and CR2 should be approximately 6.6 volts.

DUAL FRONT END ALIGNMENT

Refer to Receiver MAINTENANCE MANUAL for Receiver Mixer and IF Alignment Procedure.

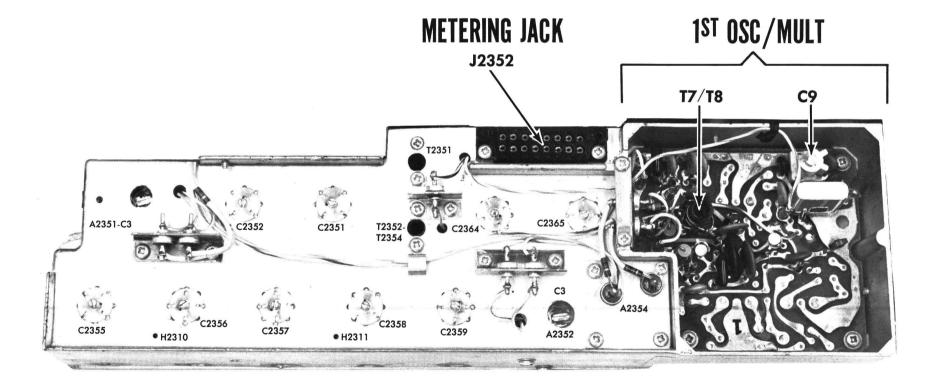
EQUIPMENT REQUIRED

- 1. G-E Test Set Model 4EX3A10 (or a 20,000 ohm-per-volt multimeter).
- 2. Signal Generator (406-470 MC range). Connect a one-inch piece of insulated wire no larger than .065-inch diameter to generator output probe.

PRELIMINARY CHECKS AND ADJUSTMENTS

- With Test Set in position J, check for regulated +10 volts. If using multimeter, measure at metering jack J2352-13 and -16.
- 2. If using Multimeter for alignment, connect positive lead to J2352-16 (ground).
- 3. Set frequency selector switch on control unit to F2 position.

If Receiver and Dual Front End operating frequencies are less than 2 MC apart, connect the signal generator directly into the Dual Front End antenna connector J1, not into the "T" connector.



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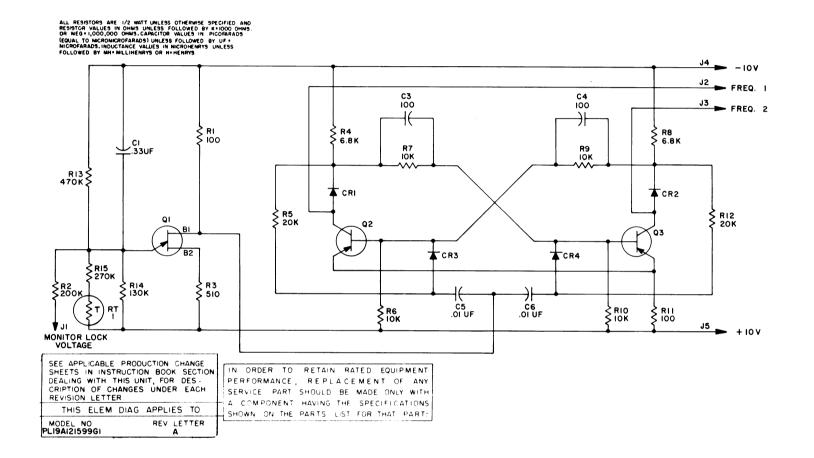
	METERING POSITION								
	G-E	Multimeter Minus at		METER					
STEP	Test Set	J2352	TUNING CONTROL	READING	PROCEDURE				
OSCILLATOR AND MULTIPLIERS									
1			C9 (on 1st OSC/ MULT)	See Procedure	Set C9 to approximately mid-frequency range.				
2	D (MULT-1)	Pin 4	T7/T8 (on 1st OSC/MULT)	Maximum	Tune T7/T8 for maximum meter reading.				
3	D (MULT-1)	Pin 4	T2351/T2353	Minimum	Tune T2351/T2353 for minimum meter reading.				
4	E (MULT-2)	Pin 5	T7/T8 (on 1st OSC/MULT), T2351/T2353 and T2352/T2354	Maximum	Tune T7/T8, T2351/T2353 and T2352/T2354 for maximum meter reading. If two peaks occur, use the peak that occurs with the slug nearest the top of the coil form.				
5	E (MULT-2)	Pin 5	C2364	Minimum	Tune C2364 for a small dip in meter reading.				
6	A (DISC)	Pin 10		Zero	Insert signal generator probe into H2311. Adjust signal generator for zero meter reading.				
7	В	Pin 2	T2352/T2354, C2364 and C2365	Maximum	Tune T2352/T2354, C2364 and C2365 for maximum meter reading.				
			RF CIR	CUITS					
8	В	Pin 2	A2352-C3, C2359, C2358, C2356, C2357 and C2358	Maximum	Apply an on-frequency signal into holes as shown below. Insert probe into hole only deep enough to obtain a reading. Insert Probe In: Tune: 1. H2311 A2352-C3, C2359 and C2358 2. H2310 C2356, C2357 and C2358				
9	В	Pin 2	C2355, C2356, C2357, C2358 C2359 and A2352-C3	See Procedure	For standard models, apply an on-frequency signal to the antenna jack (J1) and tune C2355 for maximum meter reading. Then retune C2356 thru C2359 and A2352-C3 for best sensitivity.				
10	В	Pin 2	C2351, C2352, A2351-C3, C2355 thru C2359 and A2352-C3	See Procedure	For models with UHS, apply an on-frequency signal to the antenna jack (J1) and tune C2351, C2352 and A2351-C3 for maximum meter reading. Then retune C2351, C2352, A2351-C3, C2355 thru C2359, and A2352-C3 for best sensitivity.				
			FREQUENCY	ADJUSTMENT					
11	A (DISC)	Pin 10	C9 (on 1st OSC/MULT)	Zero	Apply a 10 μv or greater onfrequency signal to the antenna jack, and adjust C9 for zero discriminator reading.				

ALIGNMENT PROCEDURE

406-470 MC, DUAL FRONT END 19D402799-G1 thru G8

Issue 1 9

SCHEMATIC DIAGRAM



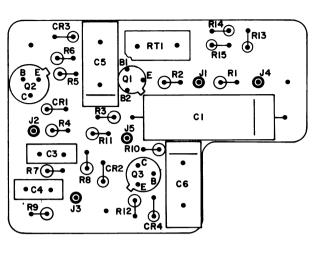
(19B204847, Rev. 3)

OUTLINE & SCHEMATIC DIAGRAM

SEARCH-LOCK MONITOR PL-19A121599-G1

10 Issue 2

OUTLINE DIAGRAM



CONNECTIONS								
	FROM TO							
WIRE COLOR	WIRE COLOR SEARCH LOCK MONITOR BD.							
G-BK-R	JI	P443-20						
W-Y-BR	J2	P443-6						
W-Y-R	J3	P443-7						
W-0	111	P443-13						
W-R	J5	P443-12						

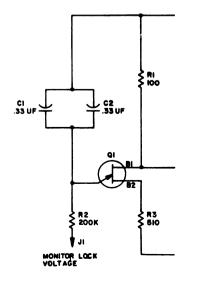
(19C303818, Rev. 1)

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A - To increase search rate. Deleted C2, added R13, R14, R15 and RT1.

Elementary Diagram Was:



PARTS LIST

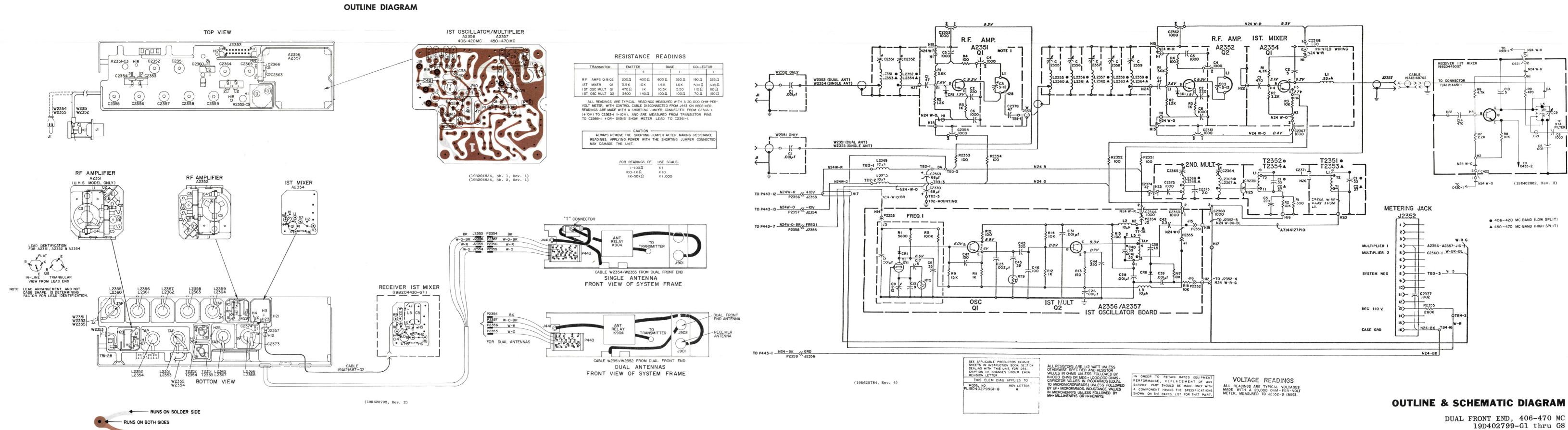
LBI-3799A

SEARCH LOCK MONITOR KIT 19A121599G1 (Mobile)

SYMBOL	GE PART NO.	DESCRIPTION
CR5	5494922P1	
		COMPONENT BOARD ASSEMBLY 19B204748G1
C1	7491930P11	Polyester: 0.33 µf ±20%, 100 VDCW; sim to GE Type 61F.
C2*	7491930P11	Polyester: 0.33 µf ±20%, 100 VDCW; sim to GE Type 61F. Deleted by REV A.
C3 and C4	5490008P127	Silver mica: 100 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15,
C5 and C6	19A115028P107	Polyester: 0.01 μf ±20%, 200 VDCW.
		DIODES AND RECTIFIERS
CR1 thru CR4	5494922P1	Silicon; sim to Type 1N456.
J1 thru J5	4033513P4	Contact, electrical: sim to Bead Chain L93-3.
		TRANSISTORS
Q1	19All5364Pl	Silicon, unijunction; sim to Type 2N2646.
Q2 and Q3	19A115706P1	Silicon, PNP; sim to Type 2N3638.
		RESISTORS
R1	3R152P101K	Composition: 100 ohms ±10%, 1/4 w.
R2	3R152P204J	Composition: 0.2 megohm ±5%, 1/4 w.
R3	3R152P511J	Composition: 510 ohms ±5%, 1/4 w.
R4	3R152P682J	Composition: 6800 ohms ±5%, 1/4 w.
R5	3R152P203J	Composition: 20,000 ohms ±5%, 1/4 w.
R6 and R7	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.
R8	3R152P682J	Composition: 6800 ohms ±5%, 1/4 w.
R9 and R10	3R152P103J	Composition: 10,000 ohms $\pm 5\%$, 1/4 w.
R11	3R152P101J	Composition: 100 ohms ±5%, 1/4 w.
R12	3R152P203J	Composition: 20,000 ohms $\pm 5\%$, $1/4$ w.
R13*	3R152P474J	Composition: 0.47 megohm ±5%, 1/4 w. Added by REV A.
R14*	3R152P134J	Composition: 0.13 megohm $\pm 5\%$, $1/4$ w. Added by REV A.
R15*	3R152P274J	Composition: 0.27 megohm ±5%, 1/4 w. Added by REV A.
RT1*	5490828P37	Rod, thermal; 0.12 megohm ±10%; sim to Globar Type 783F. Added by REV A.
		MISCELLANEOUS
	19A121592G1	Mobile support assembly,
	7140624P3	Spacer. (Located between board and support).
	19A121603G1	Cable Assembly, 24 inches long.
*		FIED OR CHANGED BY PRODUCTION CHANGES

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

SCHEMATIC DIAGRAM



RUNS ON COMPONENT SIDE

Issue 2

LBI-3795

PARTS LIST LBI-3794A

SYMBOL	GE PART NO.	DESCRIPTION
		19D402799G1 406-420 MHz DUAL ANT 19D402799G2 450-470 MHz DUAL ANT 19D402799G3 406-420 MHz PRE AMP, DUAL ANT 19D402799G4 450-470 MHz PRE AMP, DUAL ANT 19D402799G6 406-420 MHz SINGLE ANT 19D402799G7 406-420 MHz SINGLE ANT 19D402799G8 450-470 MHz SINGLE ANT 19D402799G8 450-470 MHz PRE AMP, SINGLE ANT
A2351		RF AMPLIFIER ASSEMBLY A2351 19C303671G1
C1	5496218P755	
C2	5493392P105	-750 PPM. Ceramic, stand off: 220 pf +100% -0%, 500 VDC sim to Allen-Bradley Type SS5A.
СЗ	7484389P2	Variable, ceramic: approx 3-12 pf, 500 VDCW, temp coef 0 PPM; sim to Erie Style 503.
C4	5493392P7	Ceramic, feed thru: .001 µf +100%-0%, 500 VDC sim to Allen-Bradley Type FA5C.
C5 and	5493392P107	Ceramic, stand-off: .001 µf +100%-0%, 500 VDC sim to Allen-Bradley Type SS5A.
C6		DIODES AND RECTIFIERS
CR1	4038642P1	Germanium.
El	4034512P3	
		RST-MM-10-TUR.
Ll	19A121716P1	Coil.
Q1*	19A116032P1	TRANSISTORS
42.	10,111000211	Earlier than REV A:
	19A115441P1	Silicon, NPN.
Rl	3R152P362J	
R2	3R152P122J	Composition: 1200 ohms ±5%, 1/4 w.
R3	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.
R4	3R152P101K	Composition: 100 ohms ±10%, 1/4 w.
A2352		RF AMPLIFIER ASSEMBLY A2352 19C303671G2
Cl	5496218P755	Ceramic disc: 47 pf ±5%, 500 VDCW, temp coef -750 PPM.
C2	5493392P105	Ceramic, stand off: 220 pf +100%-0%, 500 VDC sim to Allen-Bradley Type SS5A.
СЗ	7484389P2	Variable, ceramic: approx 3-12 pf, 500 VDCW, temp coef 0 PPM; sim to Erie Style 503.
C4	5493392P7	Ceramic, feed thru: .001 µf +100%-0%, 500 VD sim to Allen-Bradley Type FASC.
C5 and C6	5493392P107	Ceramic, stand-off: .001 µf +100%-0%, 500 VD sim to Allen-Bradley Type SS5A.
CR1	4038642P1	DIODES AND RECTIFIERS Germanium.

YMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTI
			C42	5491601P130	Phenolic: 3.3 pf ±5%, 500 VDCW; sim to Quality			CRYST.
El	4034512P3	Terminal, feed-thru: sim to Sealectro RST-MM-10-TUR.	C43	5496219 P 5	Components Type MC. Ceramic disc: 39pf ±5%, 500 VDCW, temp coef 0 PPM.			When reordering give GE Present freq needed.
		INDUCTORS	C44	5490008P135	Silver mica: 220 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15.	¥1	19B206576P6	Crystal freq = (OF -12.4) Quartz: freq range 16401 temp range -30°C to +85°C
L1	19A121716P1	Coil.	C45	5490008 P 35	Silver mica: 220 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.	¥1	19B206576P7	Quartz: freq range 18233 temp range -30°C to +85°C
Q2*	19A116032P1	Silicon, NPN. Earlier than REV A:	C46	5496219 P 563	Ceramic disc: 100 pf ±5%, 500 VDCW, temp coef -330 PPM.			
	19A115440P1	Silicon, NPN.	C47	5496219P767	Ceramic disc: 150 pf ±5%, 500 VDCW, temp coef -750 PPM.	C2353 and C2354	5493392P7	Ceramic, feed thru: .001 sim to Allen-Bradley Type
R1	3R152P362J		CR6	19A115250Pl	Silicon.	C2360	5493392 P 7	Ceramic, feed thru: .001 sim to Allen-Bradley Type
R2	3R152P122J	Composition: 1200 ohms ±5%, 1/4 w.			JACKS AND RECEPTACLES	C2363 C2366	5493392P7	
R3	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.	J1 thru	4033513 P4	Contact, electrical: sim to Bead Chain L93-3.	thru C2368	3493392P1	Ceramic, feed thru: .001 sim to Allen-Bradley Type
R4 .2354	3R152P101K	Composition: 100 ohms ±10%, 1/4 w. FIRST MIXER ASSEMBLY	J6 J15 and	4033513 P 4	Contact, electrical: sim to Bead Chain L93-3.	C2369 and C2370	5496267P11	Tantalum: 68 µf ±20%, 15 Sprague Type 150D.
		19B205642G1	J16		INDUCTORS	C2371	5491601P120	Phenolic: 1.0 pf ±5%, 50 Components Type MC.
Cl	5494481 P8		L2 and	7488079 P 16	Choke, RF: 10 µh ±10%, 0.6 ohm DC res max; sim to Jeffers 4421-7K.	C2375	5494481P12	Ceramic disc: .001 pf ±1 RMC Type JF Discap.
C2	5496218P236	RMC Type JF Discap. Ceramic disc: 5 pf ±0.25 pf, 500 VDCW, temp	L3		TRANSISTORS	C2377	7774750 P 6	Ceramic disc: .002 μf +1
C2	5490216P230	coef -80 PPM.	Q1 and	19A115330Pl	Silicon, NPN.	C2378	5496218P755	Ceramic disc: 47 pf ±5% temp coef -750 PPM.
Ll	7488079P2		Q2		RESISTORS			DIODES AND
11	140001012	sim to Jeffers 4411-2M.	R1	3R152P562J	Composition: 5600 ohms ±5%, 1/4 w.	CR2351	19A121975P1	Silicon, capacitive.
		TRANSISTORS	R9	3R152P153J	Composition: 15,000 ohms ±5%, 1/4 w.			JACKS AND I
Q1*	19A116032P1	Silicon, NPN.	R10	3R152P101K	Composition: 100 homs ±10%, 1/4 w.	J2352	19B205689G2	Connector: 16 contacts.
	19A115440P1	Earlier than REV A: Silicon, NPN.	R11 and R12	3R152P102J	Composition: 1000 ohms ±5%, 1/4 w.	J2353 thru J2356	7147199 P 1	Connector: male contact Electronics 21803.
		RESISTORS	R13	3R152P151J	Composition: 150 ohms ±5%, 1/4 w.	J2357	19A115465P1	Connector: receptacle, a Micon Electronics Type 1
R1	3R152P472J	Composition: 4700 ohms ±5%, 1/4 w.	R14 R15	3R152P103J 3R152P101K	Composition: 10,000 ohms ±5%, 1/4 w. Composition: 100 ohms ±10%, 1/4 w.			INDU
R2	3R152P222J	Composition: 2200 ohms ±5%, 1/4 w.	R17	3R152P103K	Composition: 10,000 ohms ±10%, 1/4 w.	L2369	7488079P18	Choke, RF: 15 μh ±10%, 1
R3	3R152P103J	Composition: 10,000 ohms ±5%, 1/4 w.	and R18		, , , , , , , , , , , , , , , , , , , ,	and L2370		sim to Jeffers 4421-9K.
2356 nd 2357		FIRST OSCILLATOR ASSEMBLY A2356 19B204419G19 405-420 MHz A2357 19B204419G22 450-470 MHz	R20	3R152P270K	Composition: 27 ohms ±5%, 1/4 w.	P2351 thru	4029840P2	Contact, electrical: si
		CAPACITORS	RT5	19B209284P7	Disc: 62 ohms, color code violet.	P2355		RESI
Cl	5494481P112	Ceramic disc: .001 pf ±10%, 500 VDCW; sim to RMC Type JF Discap.	RT9	19B209284P8	Disc: 945 ohms, color code gray.	R2351 and	3R152P101K	Composition: 100 ohms ±
C5	5496219P751	Ceramic disc: 33 pf ±5%,500 VDCW, temp coef -750 PPM.			TRANSFORMERS	R2352 R2353	3R152P101K	Composition: 100 ohms ±
C9	5491271P106	Variable: approx 2.1 to 12.7 pf, 750 v peak; sim to EF Johnson 189.	T7 and		COIL ASSEMBLY T7 19B204950G1 (A2356) T8 19B204950G2 (A2357)	and R2354		
C13	5496219P40	Ceramic disc: 9 pf ±0.25 pf, 500 VDCW, temp coef 0 PPM.			CAPACITORS	R2355	19A116278P444	Metal film: 0.28 megohm
C17	19C300685P93	Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM.	C40	5496218P253	Ceramic disc: 39 pf ±5%, 500 VDCW, temp coef -80 PPM. (Used in A2356)			TRANSF
C23	5494481P114	Ceramic disc: .002 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	C41	5496218P251	Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -80 PPM, (Used in A2357)	T2351		COIL A 19B20
C26	5494481P112	Ceramic disc: .001 pf ±10%, 500 VDCW; sim to RMC Type JF Discap.			INDUCTORS			CAPACI
C28	5494481P112	Ceramic disc: .001 pf ±10%, 500 VDCW; sim to RMC Type JF Discap.	L5	19A121728P1	Coil.	C1	5496218P251	Ceramic disc: 33 pf ±5% coef -80 PPM.
C31	5494481P112	Ceramic disc: .001 pf ±10%, 500 VDCW; sim to RMC Type JF Discap.			MISCELLANEOUS			INDU
C38	5491601P123	Phenolic: 1.5 pf ±5%, 500 VDCW; sim to Quality Components Type MC.		5491798P7	Tuning slug.	L1	19B204946P7	Coil.
C39	5494481P112	Ceramic disc: .001 pf ±10%, 500 VDCW; sim to RMC Type JF Discap.	XY1		Refer to Mechanical Parts (RC-1513).		5491798P7	Tuning slug.

SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMI
			т2352		COIL ASSEMBLY	
		When reordering give GE Part No. and specify			19B204944Gl	J
		exact freq needed.			CAPACITORS	
¥1	19B206576P6	Crystal freq = (OF -12.4 MHz)	C1	5496218P251	Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -80 PPM.	
11	19820657696	Quartz: freq range 16401.11 to 16983.333 KHz temp range -30°C to +85°C.	СЗ	5494481 P 3	Ceramic disc: 220 pf ±20%, 1000 VDCW; sim to	
¥1	19B206576P7	Quartz: freq range 18233.333 to 19066.66 KHz temp range -30°C to +85°C.			RMC Type JF Discap.	
			C4	5491601P120	Phenolic: 1.0 pf ±5%, 500 VDCW.	W2:
					DIODES AND RECTIFIERS	W2
C2353 and C2354	5493392P7	Ceramic, feed thru: .001 μf +100%-0%, 500 VDCW; sim to Allen-Bradley Type FA5C.	CR1	19A121975P1	Silicon, capacitive.	"
C2360	5493392P7	Ceramic, feed thru: .001 µf +100%-0%, 500 VDCW;				
thru C2363		sim to Allen-Bradley Type FA5C.	Li	19A121715P1	Co11.	
C2366	5493392P7	Ceramic, feed thru: .001 \(\mu f + 100\%-0\%, 500 \) VDCW;			RESISTORS	
thru C2368		sim to Allen-Bradley Type FA5C.	R1	3R152P152J	Composition: 1500 ohms ±5%, 1/4 w.	1
C2369 and	5496267 P 11	Tantalum: 68 µf ±20%, 15 VDCW; sim to Sprague Type 150D.	R2	3R152P103K	Composition: 10,000 ohms ±10%, 1/4 w.	
C2370					MISCELLANEOUS	1
C2371	5491601P120	Phenolic: 1.0 pf $\pm 5\%$, 500 VDCW; sim to Quality Components Type MC.		5491798 P 7	Tuning slug.	
C2375	5494481P12	Ceramic disc: .001 pf ±10%, 1000 VDCW; sim to	T2353		COIL ASSEMBLY	
C2377	7774750 P 6	RMC Type JF Discap. Ceramic disc: .002 µf +100% -0%, 500 VDCW.	12303		19B204946G2	
C2378	5496218 P 755	Ceramic disc: 47 pf ±5%, 500 VDCW,				
		temp coef -750 PPM.	C2	5496218P249	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef	
		DIODES AND RECTIFIERS		1	-80 PPM.	
CR 2351	19A121975P1	Silicon, capacitive.	L1	19B204946P7	Coil.	
		JACKS AND RECEPTACLES			MISCELLANEOUS	
J2352	19B205689G2	Connector: 16 contacts.		5491798P7	Tuning slug.	
J2353	7147199P1	Connector: male contact; sim to Winchester	T2354		COIL ASSEMBLY	
thru J2356		Electronics 21803.	12334		19B204944G2	
J2357	19All5465Pl	Connector: receptacle, coaxial; sim to Micon Electronics Type 1104.				1
			C2	5496218 P24 9	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef	1
L2369	7488079P18		СЗ	5494481P3	-80 PPM. Ceramic disc: 220 pf ±20%, 1000 VDCW; sim to	
and L2370	1400019110	sim to Jeffers 4421-9K.	"	010110110	RMC Type JF Discap.	
			C4	5491601P120	Phenolic: 1.0 pf ±5%, 500 VDCW.	
P2351	4029840P2	Contact, electrical: sim to Amp 42827-2.			DIODES AND RECTIFIERS	
thru P2355			C28.1	19A121975P1	Silicon, capacitive.	
		RESISTORS			INDUCTORS	
R2351 and	3R152P101K	Composition: 100 ohms ±10%, 1/4 w.	11	19A121715P1	Coil.	
R2352	0015001017				RESISTORS	
R2353 and R2354	3R152P101K	Composition: 100 ohms ±10%, 1/4 w.	R1	3R152P152J	Composition: 1500 ohms ±5%, 1/4 w.	
R2355	19A116278P444	Metal film: 0.28 megohm ±2%, 1/2 w.	R2	3R152F103K	Composition: 10,000 ohms ±10%, 1/4 w.	
		- ,			MISCELLANROUS	1
		TRANSFORMERS]]	5491798 P 7	Tuning slug.	1
T2351		COIL ASSEMBLY 19B204946G1	[]			
		15820151001	TB1	7487424P2	Miniature, phen: 2 terminals.	
		CAPACITORS	TB2	7487424P24	Miniature, phen: 3 terminals.	
C1	5496218P251	Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -80 PPM.	and TB3			"
			TB4	7487424P23	Miniature, phen: 1 terminal.	R
Ll	19B204946P7	Coil.				
		MISCELLANEOUS	W2351		CABLE ASSEMBLY	
	5491798 P 7	Tuning slug.	and W2352		19B204930G1	1
			C1	19B209141P1		
			"	19920914191	Ceramic disc: .001 µf ±19%, 500 VDCW.	

	SYMBOL	GE PART NO.	DESCRIPTION		SYMBOL	GE PART NO.	DESCRIPTION
	Jl	2R 2 2P3	JACKS AND RECEPTACLES Receptacle: coaxial, Signal Corps SO-239 or sim to Ammhenol 83-1R.			19A115465P1	Receptacle, coaxial: 500 v, sim to Micon Electronics Type 1104. (Mounts on First Mixer).
-		19B204398P3 19A121436P1	Can.			19B204924G1	
		19B201074P206	Screw, tap.			19A121687G2	Cable, RF: approx 11 inches.
١	W2353	19B209044P13	RF: approx 4 inches; sim to Amphenol 421-105.			19A122563G3	Cable, RF: approx 3 inches. (Used with Single Antenna without Pre Amp).
	W2354 W2355	19A122563G1 19A122563G2	Cable, RF: approx 27 inches. Cable, RF: approx 31 inches.			19A122563G4	Cable, RF: approx 8 1/2 inches. (Used with Single Antenna with Pre Amp).
			RF CIRCUIT ASSEMBLY	1			FIRST MIXER 19B204430G7
			19C31119OGI (408-420 MHz WITH PRE AMP) 19C31119OG2 (450-470 MHz WITH PRE AMP) 19C31119OG3 (406-420 MHz)				
			19C311190G4 (450-470 MHz)		C5	5494481P14	Ceramic disc: .002 pf $\pm 10\%$, 1000 VDCW; sim to RMC Type JF Discap.
					C6	5494481P12	Ceramic disc: .001 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
ı	C2351		Refer to Mechanical Parts (RC-1513).	i	l ~	5401 271 0104	Vertically of the common 1 7 9 2 ms 750 m marks

Refer to Mechanical Parts (RC-1513).

Refer to Mechanical Parts (RC-1513).

Ceramic feed-thru: 47 pf +100%-0%, 500 VDCW; sim to Allen-Bradley Type FA5C.

ASSOCIATED EQUIPMENT

MODIFICATION KITS 19A122568G1-SINGLE ANTENNA 19A122568G2-DUAL ANTENNA 19A122568G3-SINGLE ANTENNA W PRE AMP

---- DIODES AND RECTIFIERS ----

----- RESISTORS ------

---- JACKS AND RECEPTACLES ----

Composition: 0.1 megohm ±10%, 1/4 w.

Connector, "T" coaxial: sim to Component Mfg. Service All73. (Mounts on frame-Used with single antenna).

5491601P25

5493392P3

19B204938G7

19B204938G8 19B204938G10

19B204936P1

19B204938G5

19B204938G12

19B204936P2

19B204938G6

19B204938G3

19B204938G1

19B204938G4

19B204938G2

19A115348P1

Coil.

Coil.

Coil.

Coil.

5491271P104

5494481P8

19A121082G5

19A115440P1

3R152P472J

3R152P103J

3R152P471K

19A121759P1

19A121759P1

19C303649P1

19A121674P1 5490407P2

4039307P1

4033089P1

19A115793P1

19A121723P1

19A121722P1

19A121724P1

7145451P1

7117825P1

4036765**G**5 19C311155P1

7142162P109

19A121515G1

4036436P2

4036436P2

C14

Variable, air: approx 1.7-8.3 pf, 750 v peak; sim to EF Johnson 189.

Ceramic disc: 470 pf \pm 10%, 1000 VDCW; sim to RMC Type JF Discap.

Ceramic disc: 4 pf ±0.25 pf, 500 VDCW; temp coef -80 PPM.

----- TRANSISTORS -----

FRONT PLATE ASSEMBLY
19B205195G1 TRUNK MOUNT SINGLE ANTENNA
19B205195G2 TRUNK MOUNT DUAL ANTENNA

FRONT PLATE ASSEMBLY
19B204446G2 FRONT MOUNT SINGLE ANTENNA
19B204446G4 FRONT MOUNT DUAL ANTENNA

Composition: 4700 ohms ±5%, 1/4 w.

Composition: 10,000 ohms ±5%, 1/4 w.

Nut, push on; sim to Fastex 8063-21-00.

Nut, push on; sim to Fastex 8063-21-00.

Composition: 470 ohms ±10%, 1/4 w.

Thumbscrew. 1/4-20 X 1 inch.

Thumbscrew. 1/4-20 X 1 inch.

Clip, spring tension (XY1).

Support (Mounts C2363 and C2366).

Support (Mounts C2361 and C2362).

Support.

Grommet, rubber.

Socket (XY1).

Plate (A2354).

Washer, spring tension.

Clip, cable.

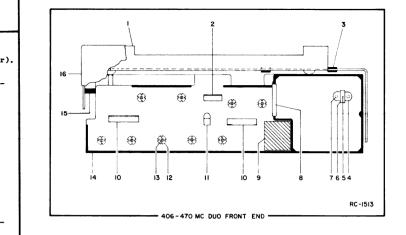
Casting, RF.

Spacer.

Rear Cap.

Ceramic disc: 5 pf ±0.25 pf, 500 VDCW, temp coef -80 PPM.

Toroidal coil.



PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A - Dual Front End 19D402799-G1-8

To replace a transistor no longer available. Changed Q1 on A2351 and Q2 on A2352.

ORDERING SERVICE PARTS

Each component appearing on the schematic diagram is identified by a symbol number, to simplify locating it in the parts list. Each component is listed by symbol number, followed by its description and G-E Part Number.

Service parts may be obtained from Authorized G-E Communication Equipment Service Stations or through any G-E Radio Communication Equipment Sales Office. When ordering a part, be sure to give:

- 1. G-E Part Number for component
- 2. Description of part
- 3. Model number of equipment
- 4. Revision letter stamped on unit

These instructions do not purport to cover all details or variations in equipment nor to provide for every possible contingency to be met in connection with installation, operation or maintenance.

Should further information be desired, or should particular problems arise which are not covered sufficiently for the purchaser's purposes, contact the nearest Radio Communication Equipment Sales Office of the General Electric Company.

MOBILE RADIO DEPARTMENT
GENERAL ELECTRIC COMPANY ● LYNCHBURG, VIRGINIA 24502

